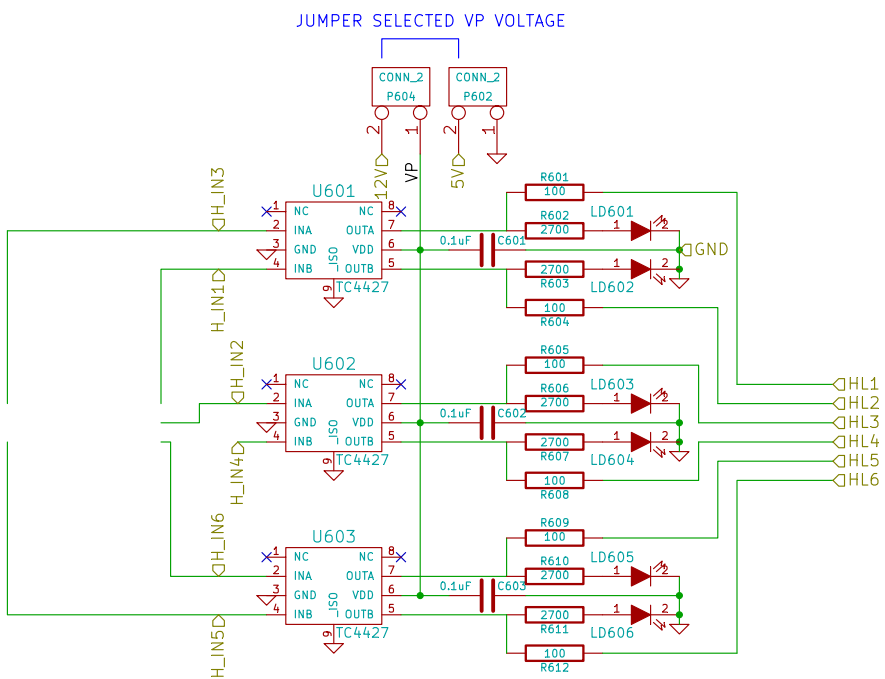
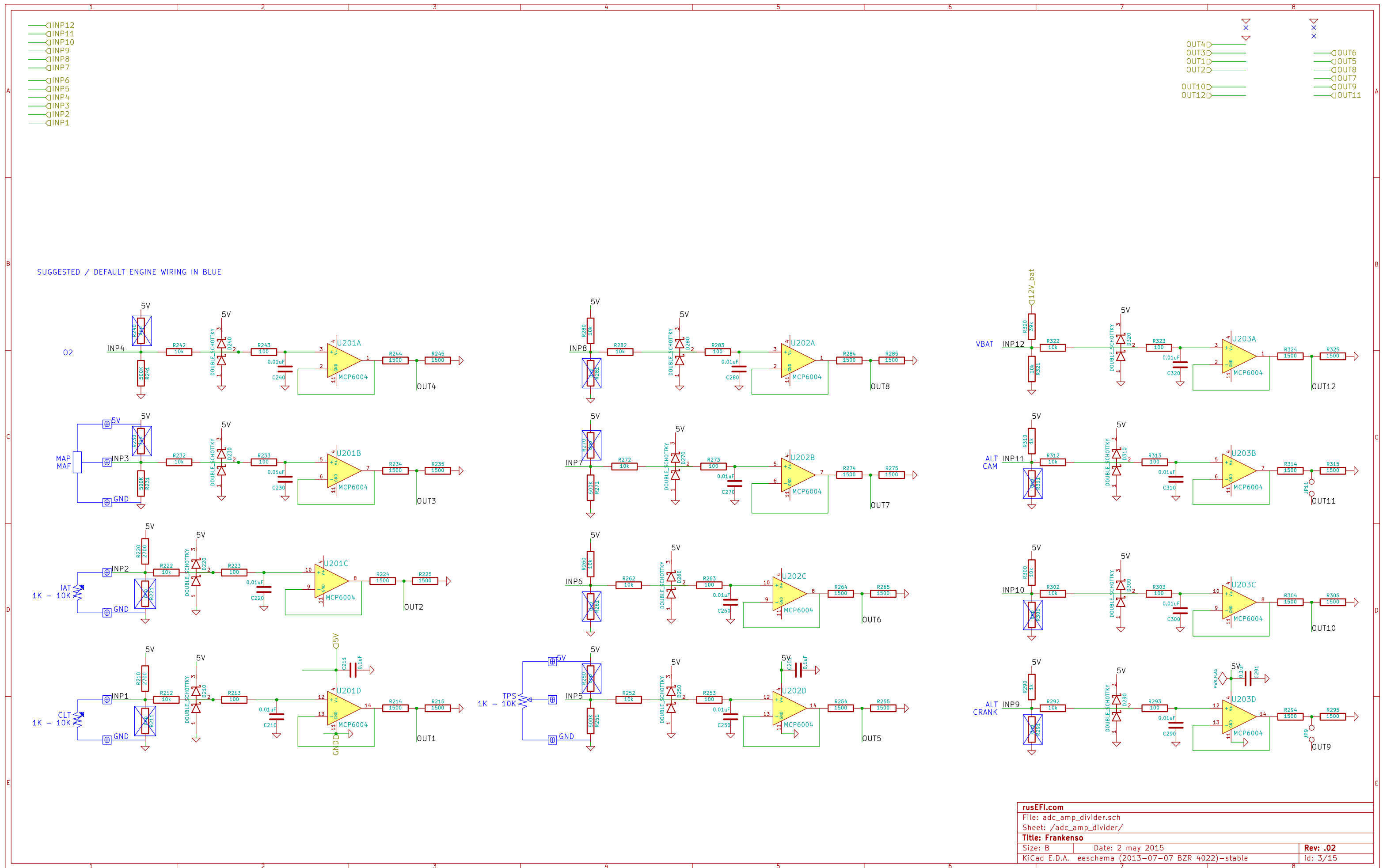
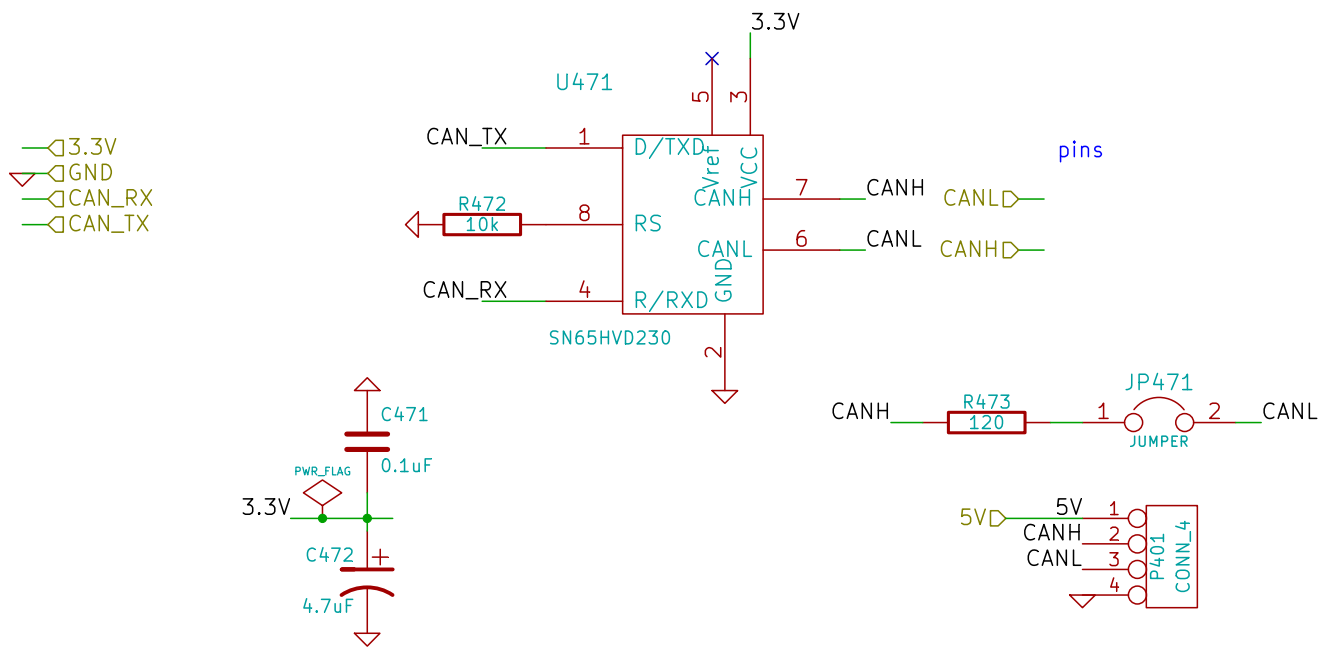


6 channel high / low side driver

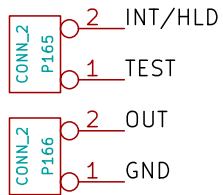
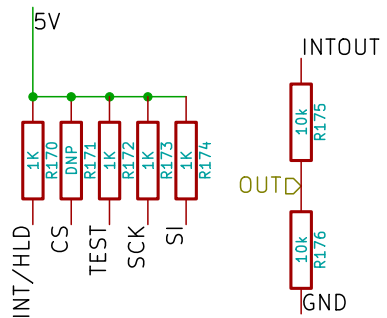
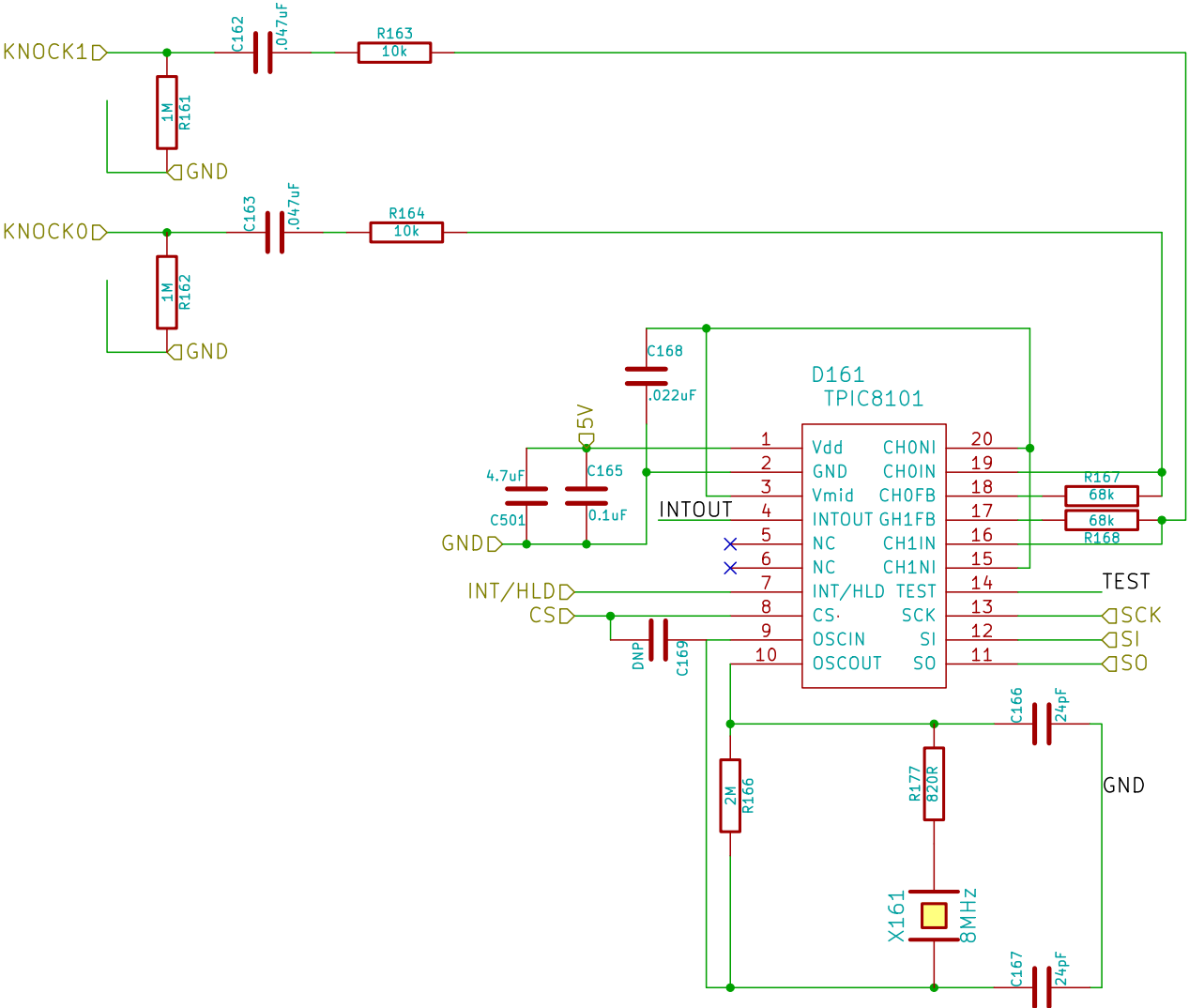






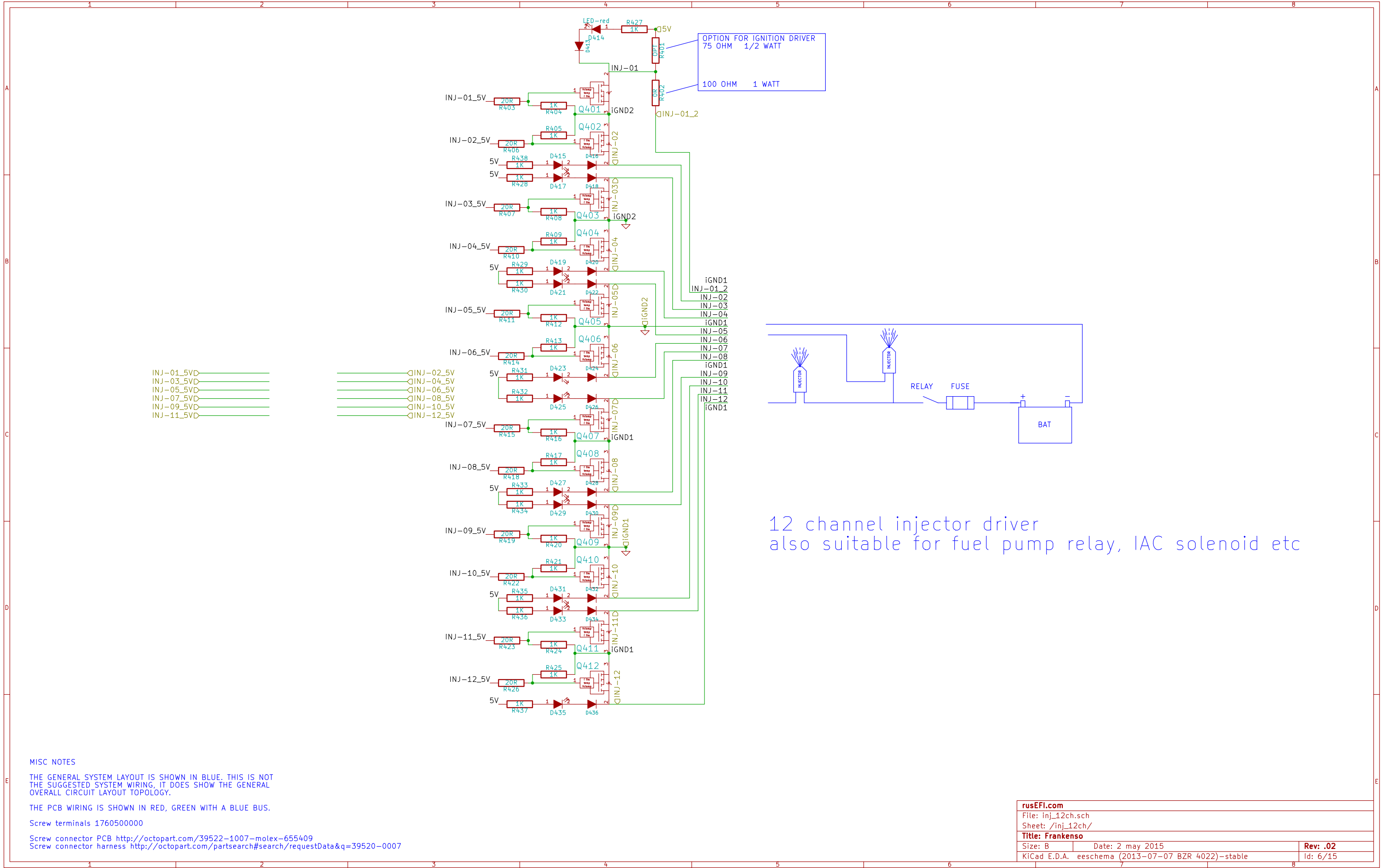
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Size: A4	Date: 2 may 2015	Rev: .02
KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 4/15

DD_HIP9011 ver.2
RusEfi.com

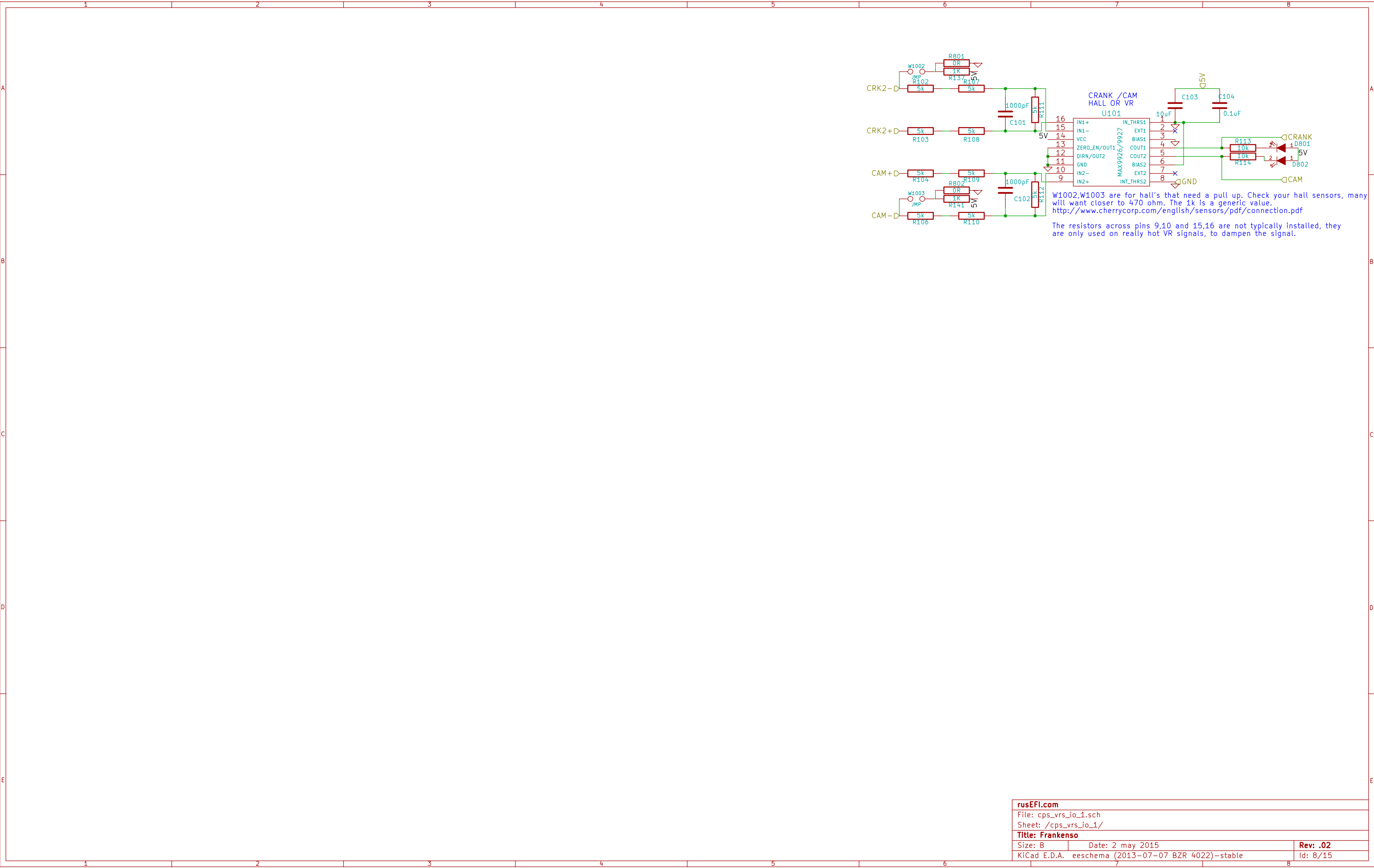


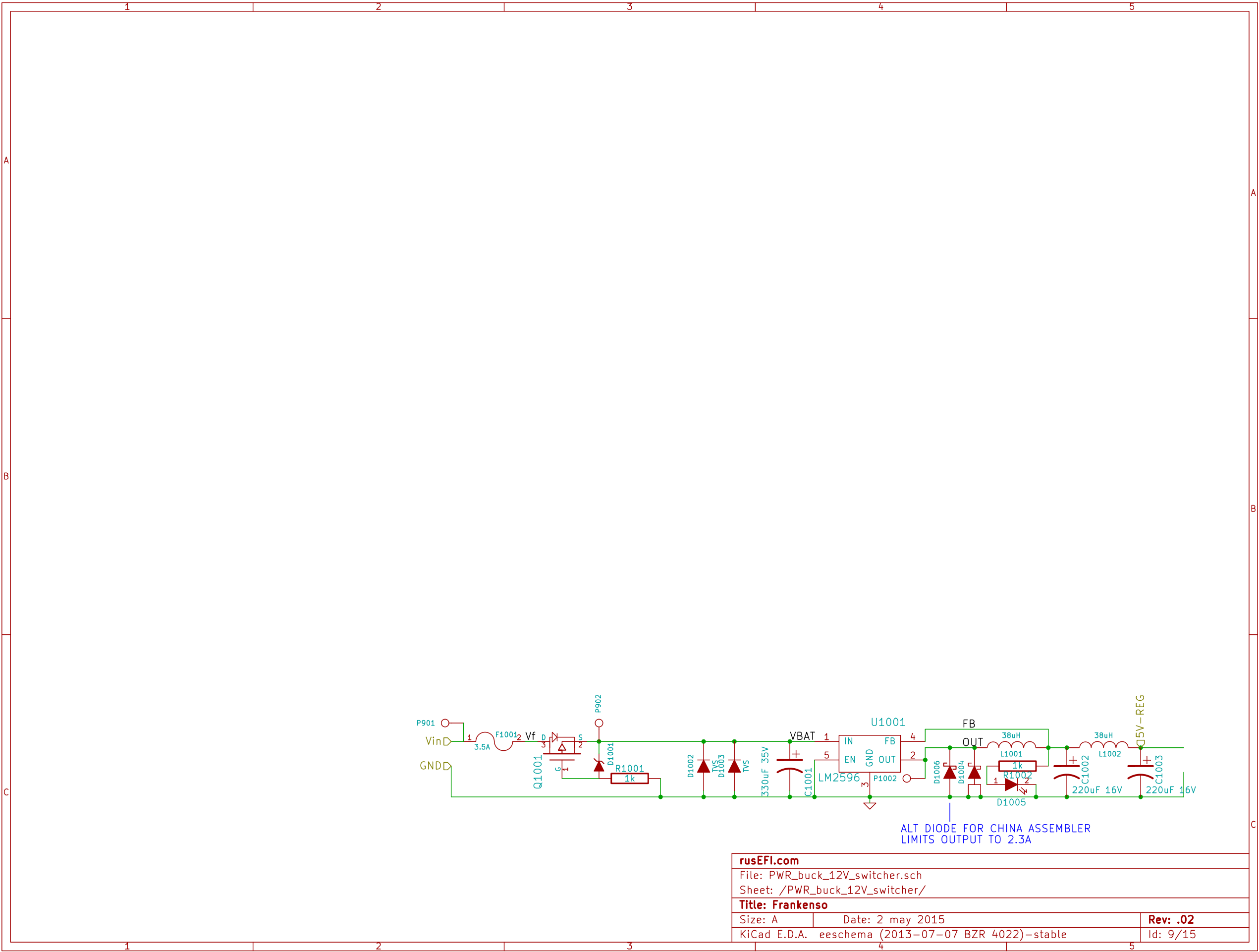
<http://www.crystek.com/documents/appnotes/Pierce-GateIntroduction.pdf>
PCB per predictions with SaturnPCB has less then 3.5pF traces,
TPIC pins assumed 5pF
ESR = 80ohms max
Rf = 2meg could be between 1meg and 10meg.
Cload = 18pF per XTAL datasheet
Cload = $\frac{([C_{in}+C_1][C_2+C_{out}])}{(C_{in}+C_1+C_2+C_{out})+PCB_{stray}}$
Cload = $\frac{([5+24][24+5])}{(5+24+24+5)+3.5} = 18pF$
C1=C2=C166=C167 = 24pF
Rs = $\frac{1}{(2\pi f C_2)} = \frac{1}{(2\pi * 8MHz * 24pF)} = 829ohms$, 820ohms is close enough = R177

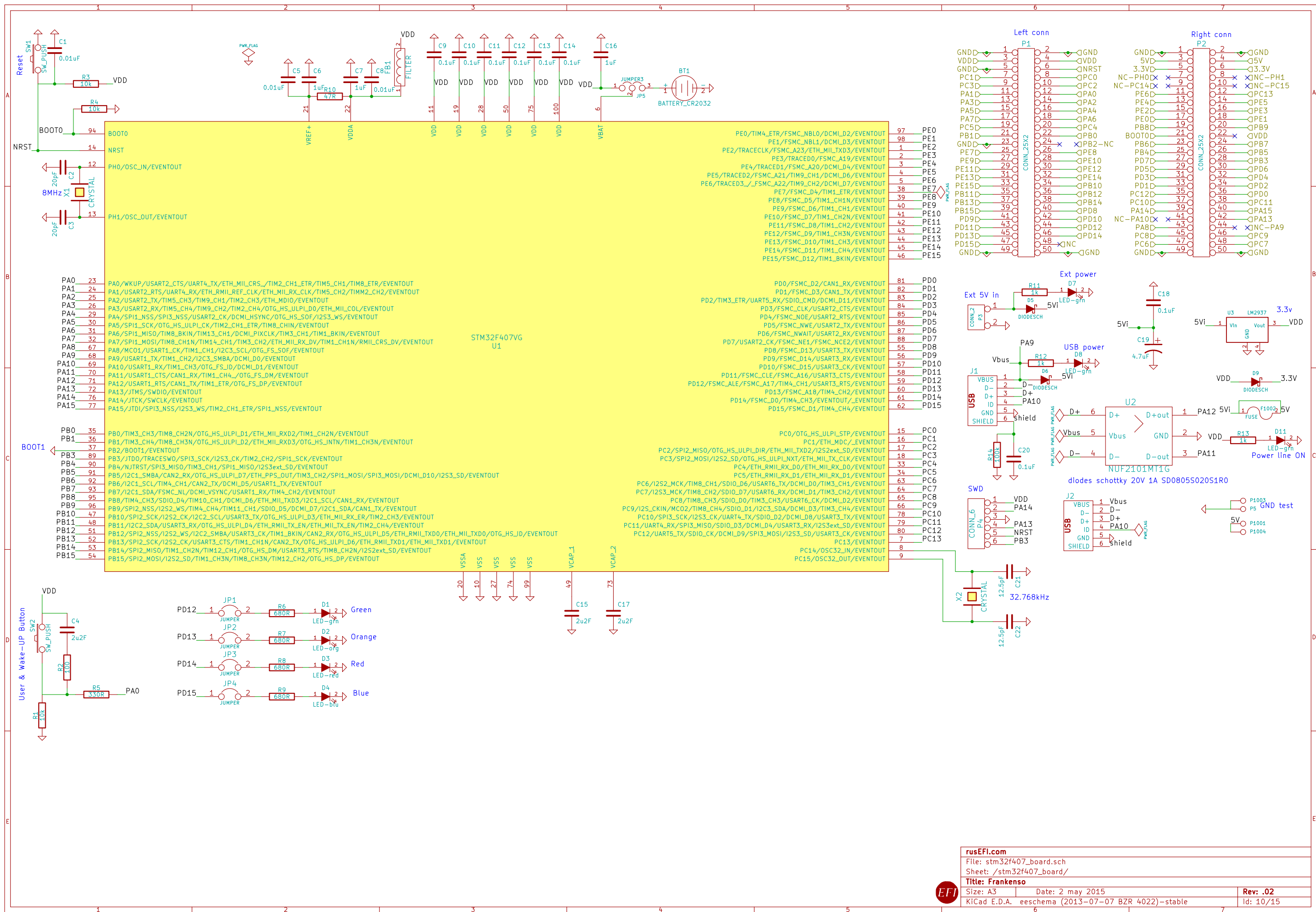
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KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 5/15

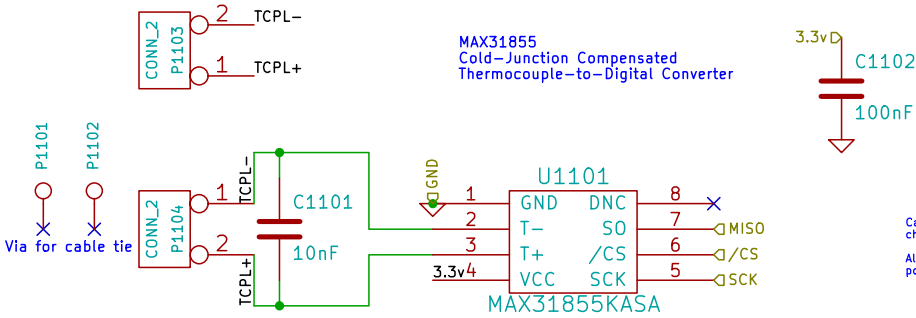


1	2	3	4	5
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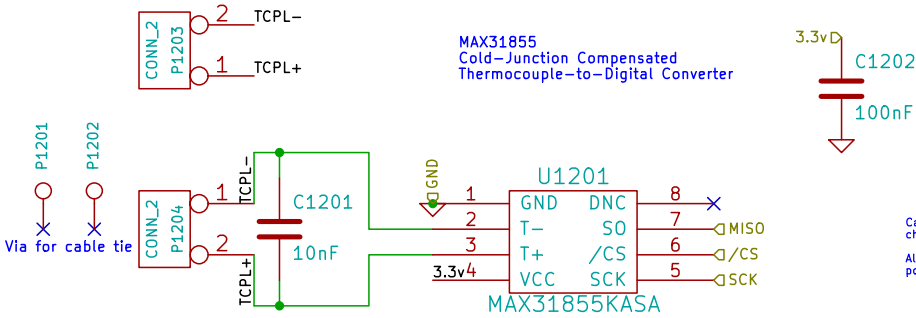




We want a big mass of copper in the TCPL joints, to dampen the cold junction temperature and to make it more measurable with this IC

Datasheet:
<http://datasheets.maxim-ic.com/en/ds/MAX31855.pdf>

Mrk Industries		
File: thermocouple_module.sch		
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Title: Electronic Industrial Temperature Interface (EITI)		
Size: A4	Date: 2 may 2015	Rev: .02
KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 11/15

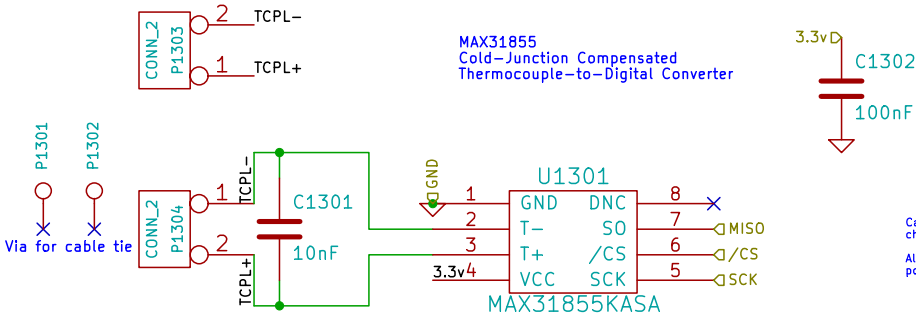


We want a big mass of copper in the TCPL joints, to dampen the cold junction temperature and to make it more measurable with this IC

Datasheet:
<http://datasheets.maxim-ic.com/en/ds/MAX31855.pdf>

Care must be taken with the conector chosen for the TCPL to avoid Inaccuracies.
Also, the connector must be as close as possible to the cold-junction compensation.

Mrk Industries		
File: thermocouple_module.sch		
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Title: Electronic Industrial Temperature Interface (EITI)		
Size: A4	Date: 2 may 2015	Rev: .02
KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 12/15

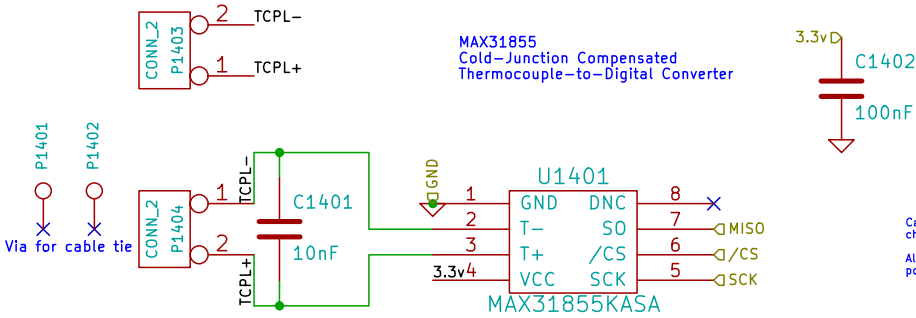


Care must be taken with the conector
chosen for the TCPL to avoid inaccuracies.
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possible to the cold-junction compensation.

We want a big mass of copper in the
TCPL joints, to dampen the cold junction
temperature and to make it more measurable
with this IC

Datasheet:
<http://datasheets.maxim-ic.com/en/ds/MAX31855.pdf>

Mrk Industries		
File: thermocouple_module.sch		
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Title: Electronic Industrial Temperature Interface (EITI)		
Size: A4	Date: 2 may 2015	Rev: .02
KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 13/15



We want a big mass of copper in the TCPL joints, to dampen the cold junction temperature and to make it more measurable with this IC

Datasheet:
<http://datasheets.maxim-ic.com/en/ds/MAX31855.pdf>

Care must be taken with the conector chosen for the TCPL to avoid Inaccuracies.
Also, the connector must be as close as possible to the cold-junction compensation.

Mrk Industries		
File: thermocouple_module.sch		
Sheet: /thermocouple4/		
Title: Electronic Industrial Temperature Interface (EITI)		
Size: A4	Date: 2 may 2015	Rev: .02
KiCad E.D.A. eeschema (2013-07-07 BZR 4022)-stable		Id: 14/15

